

# Plug-In RF Transformer

50Ω 0.05 to 200 MHz

TT4-1-X65+  
TT4-1-X65



CASE STYLE: X65

**+RoHS Compliant**

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

## Maximum Ratings

Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	250mW
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

## Pin Connections

PRIMARY DOT	4
PRIMARY	6
PRIMARY CT	5
SECONDARY DOT	3
SECONDARY	1
SECONDARY CT	2

## Features

- wideband, 0.05 to 200 MHz
- good return loss
- also available with flat-pack (W38) & surface mount gull-wing (KK81) leads

## Applications

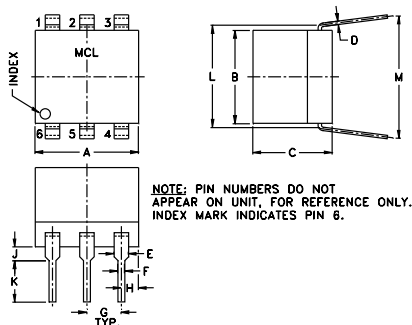
- HF/VHF
- impedance matching
- balanced antennas

## Transformer Electrical Specifications

Ω RATIO (Secondary/Primary)	FREQUENCY (MHz)	INSERTION LOSS*		
		3 dB MHz	2 dB MHz	1 dB MHz
3	0.05-200	0.05-200	0.2-50	1-30

\* Insertion Loss is referenced to mid-band loss, 0.4 dB typ.

## Outline Drawing



## Outline Dimensions (inch)

A	B	C	D	E	F	G
.30	.27	.23	.010	.042	.020	.100
7.62	6.86	5.84	0.25	1.07	0.51	2.54

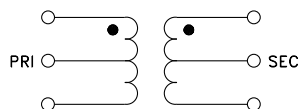
  

H	J	K	L	M	wt
.05	.04	.11	.300	.35	grams
1.27	1.02	2.79	7.62	8.89	0.50

## Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
0.05	2.88	1.46
0.10	1.29	4.13
0.20	0.58	8.81
0.50	0.39	15.77
1.00	0.36	19.03
30.00	0.51	11.31
50.00	0.91	7.28
100.86	1.96	3.92
195.15	2.78	3.87
200.00	2.76	4.08

## Config. B



## Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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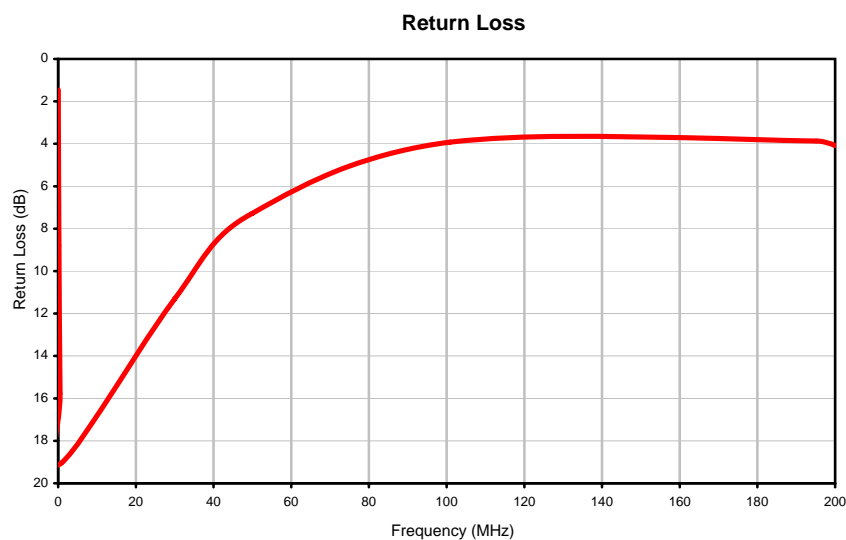
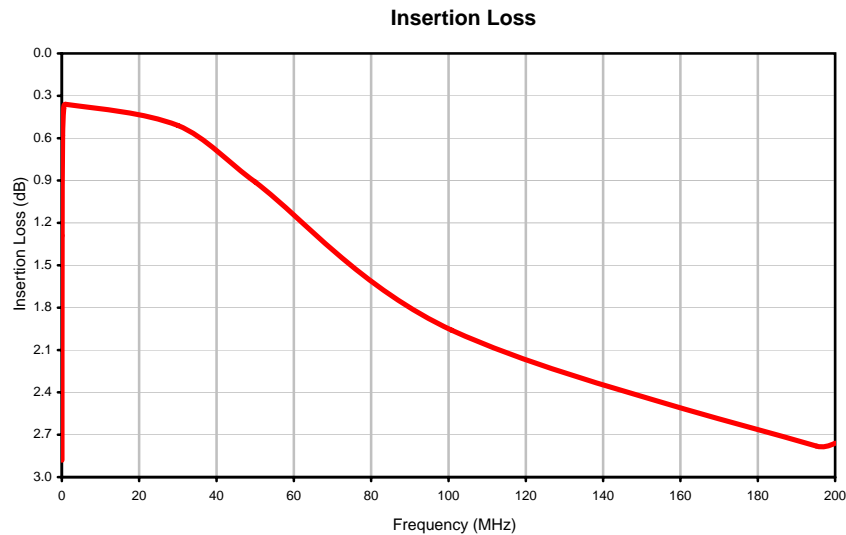
REV. B  
M151107  
TT4-1-X65  
IG/TD/CP

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*Typical Performance Data*

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.05	2.88	1.46
0.10	1.29	4.13
0.20	0.58	8.81
0.50	0.39	15.77
1.00	0.36	19.03
30.00	0.51	11.31
50.00	0.91	7.28
100.86	1.96	3.92
195.15	2.78	3.87
200.00	2.76	4.08

## Typical Performance Curves



## Outline Dimensions

**X65**



CASE #	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAM
X65	.30 (7.62)	.27 (6.86)	.23 (5.84)	.010 (0.25)	.042 (1.07)	.020 (0.51)	.100 (2.54)	.05 (1.27)	.04 (1.02)	.11 (2.79)	.300 (7.62)	.35 (8.89)	.50

Dimensions are in inches (mm)

### Notes:

- Case material: Plastic.  
Termination finish: For RoHS Case Styles: Tin Plate over Nickel Plate.  
For RoHS-5 Case Styles: Tin-Lead Plate.



INTERNET <http://www.minicircuits.com>

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Mini-Circuits ISO 9001 & ISO 14001 Certified



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Lead Integrity	2 Pound Pull, perpendicular to edge of unit	MIL-STD-202, Method 211, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215